

The basics of decoupling capacitors

How to stabilize digital supply voltages - and why most of the online advice on the topic is suspect.

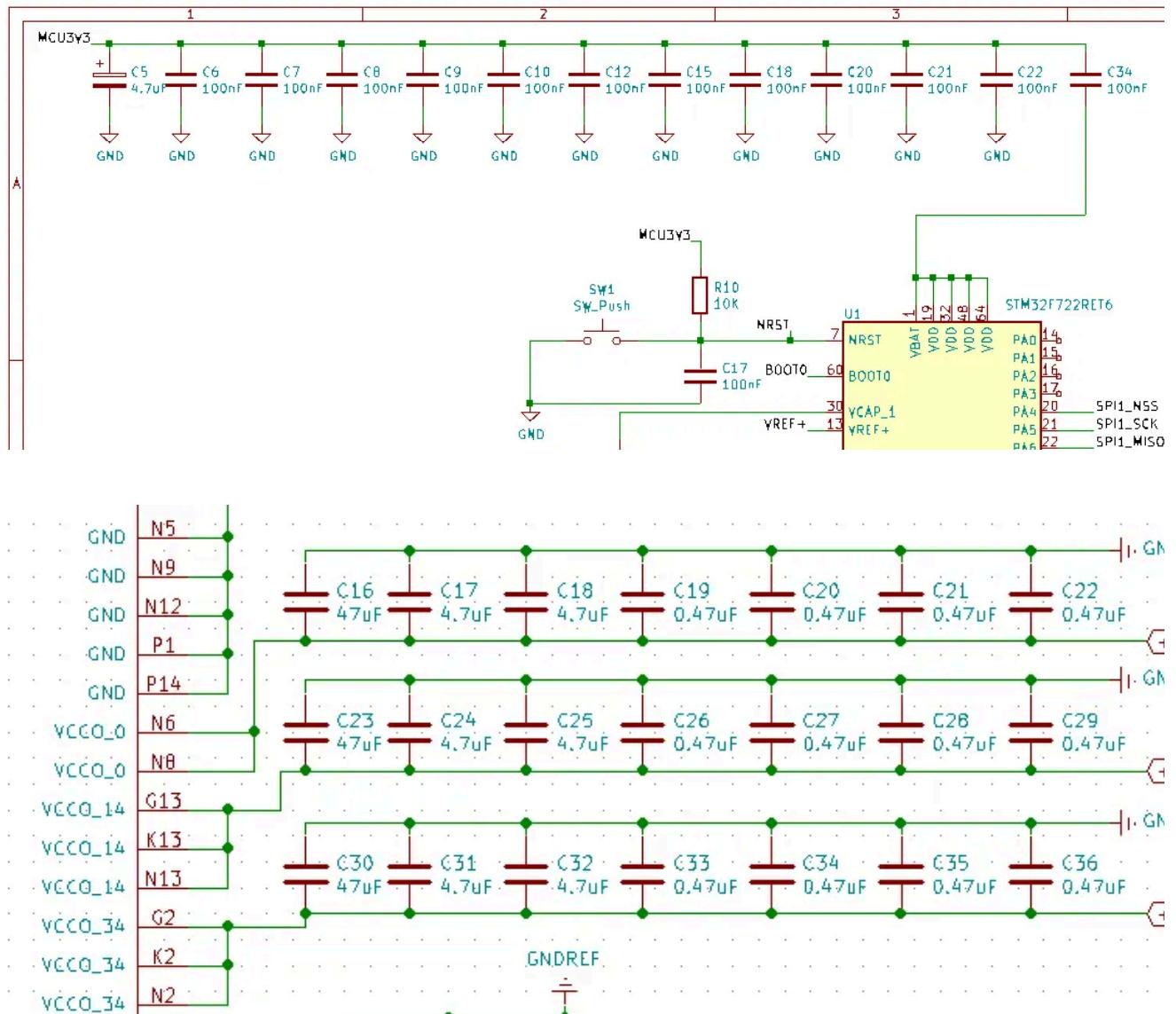
APR 16, 2023



Two decades ago, to build a portable music player, you had to clobber together several hundred electronic components. Today, you can accomplish the same with a single chip and a dozen passives. Heck, you might even get Wi-Fi and Bluetooth for free.

One of the few discrete components that survive and thrive in the face of growing integration is the humble decoupling capacitor. It's not just that the device is hard to manufacture on the die of an integrated circuit; in the world of high data speeds and low supply voltages, it has an increasingly important role to play in keeping the circuits humming along.

Among hobbyists, the understanding of decoupling caps continues to be hit-and-miss. Some folks skip them altogether and live to tell; others follow ancient lore of uncertain origins, producing monstrosities such as this:



Decoupling capacitor galore. Found on the internet.

In this article, I'm hoping to cast some light on the actual role of decoupling capacitors in digital circuits – and to offer advice on how to integrate them into your designs without going overboard.

What does a decoupling capacitor do, anyway?

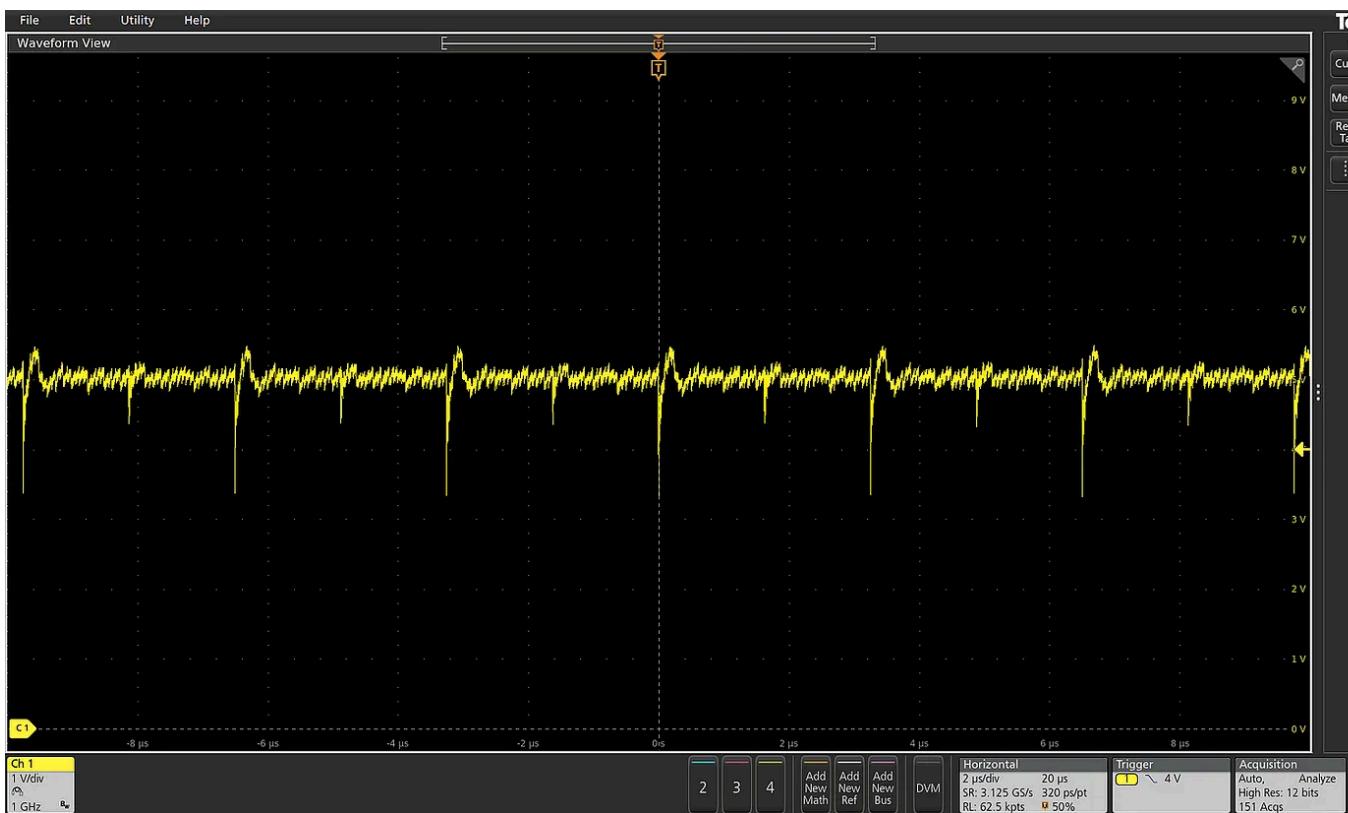
In a steady state, a typical CMOS integrated circuit needs very little power. The chip's energy consumption is associated predominantly with state transitions – that is, toggling between “zero” and “one”. That's because the

process requires moving electrons back and forth to charge or discharge the gates of field effect transistors inside the chip.

Some internal state transitions require relatively little current, but others are more demanding; this is particularly true for the operation of larger transistors that drive output lines. To toggle them at megahertz speeds – a task that demands rapid rise and fall times – the chip must momentarily source significant currents. In a typical microcontroller, the transition usually takes no more than several nanoseconds, but may involve hundreds of millamps.

This poses a challenge. At high and rapidly varying currents, PCB traces exhibit resistive losses and non-trivial inductive reactance. The imperfect load response characteristics of the power supply also get in the way. In the end, even seemingly minor digital switching can cause significant voltage fluctuations and electrical noise across the entire circuit.

The following oscilloscope plot shows the effects of a popular ATmega microcontroller repeatedly toggling a couple of unconnected output pins. MCU clock speed is 8 MHz; square wave rise time is somewhere in the ballpark of 5 ns:



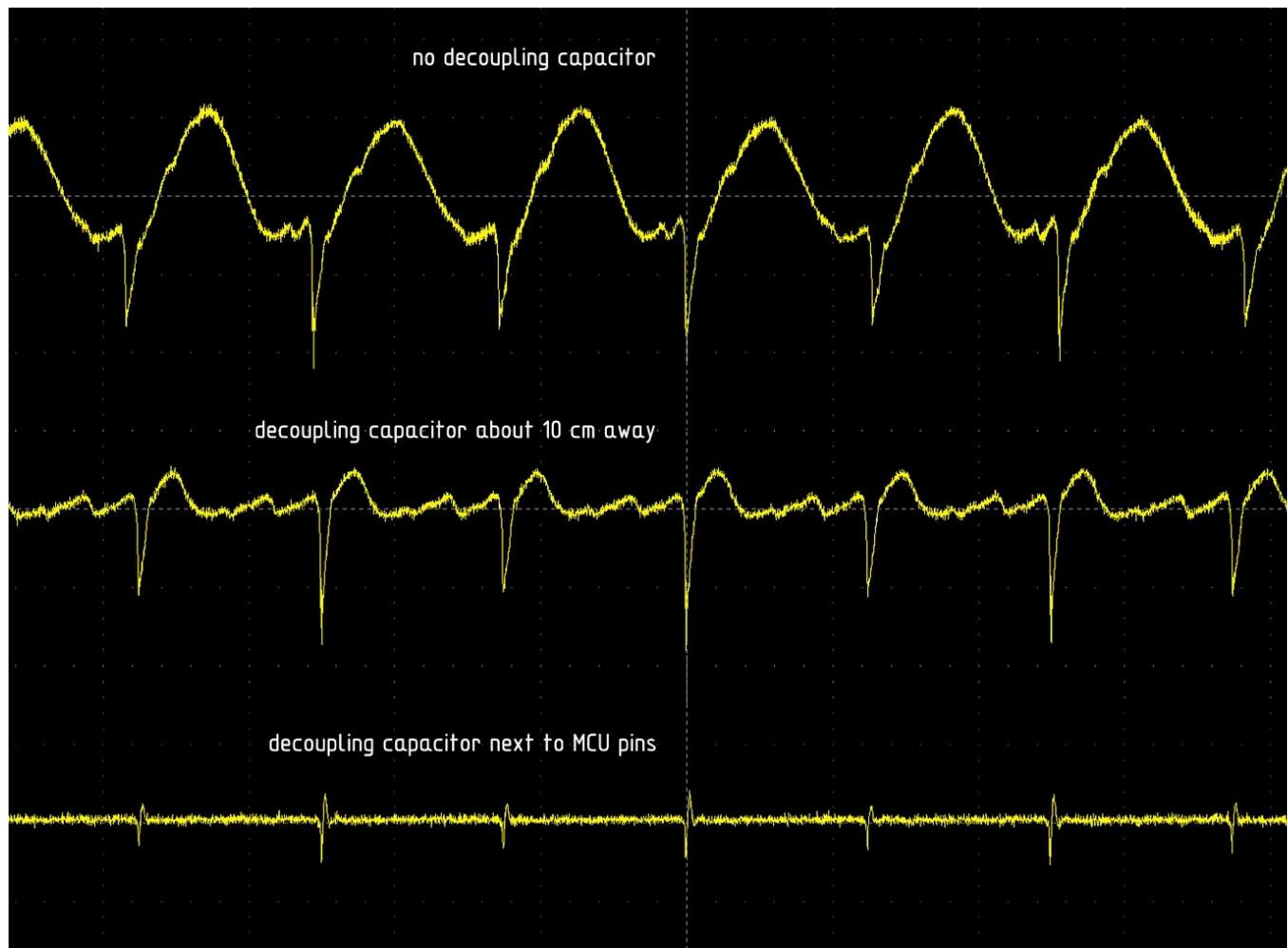
Observed supply voltage noise for a simple MCU application.

The peak-to-peak amplitude of this noise, as sampled at the MCU supply I₁, is almost 2 volts – about 40% of the nominal supply voltage. This in itself could be enough to destabilize the MCU. Just as important, because the chip no longer has a stable Vdd and GND reference shared with other parts of the circuit, interfacing it to other devices might prove difficult. It's not that this setup is *bound* to malfunction, but unexplained and hard-to-diagnose issues can creep up with ease.

This brings us to the purpose of decoupling capacitors: they are placed across the voltage supply lines and physically close to the offending chip to handle switching transients while preventing high currents and minimizing voltage fluctuations in other parts of the circuitry.

To do this, the capacitors must have low equivalent series resistance (i.e., able to charge and discharge quickly); for this reason, multilayer ceramics (MLCCs) should be used instead of the comparatively sluggish electrolytic caps. But above all, to work effectively, the capacitors must be as close as

practical to the chip's supply pins. The following oscilloscope trace captures for another mildly noisy 8-bit MCU illustrates the point:



The effect of capacitor distance on the switching noise of an AVR Dx MCU.

One could analyze the setup in terms of an [RC or LC lowpass filter](#) formed tandem with upstream and downstream impedances, but these parameters are hard to faithfully estimate. Most of the time, we go by rules of thumb: a single 100 nF to 1 μ F MLCC per supply domain, operated well clear of its maximum voltage, is typically enough to deal with all intrinsic switching currents of PIC, AVR, or mid-range ARM microcontrollers.

Beyond this, additional “bulk” capacitance might be appropriate if the MCU is driving substantial loads. This can be accomplished with a single larger MLCC (e.g., 10 μ F); with several smaller MLCCs in parallel; or with a small fast-acting MLCC coupled with a larger but slower aluminum-polymer cap (10–100 μ F).

the latter configuration, the larger capacitor can be safely placed some distance away.

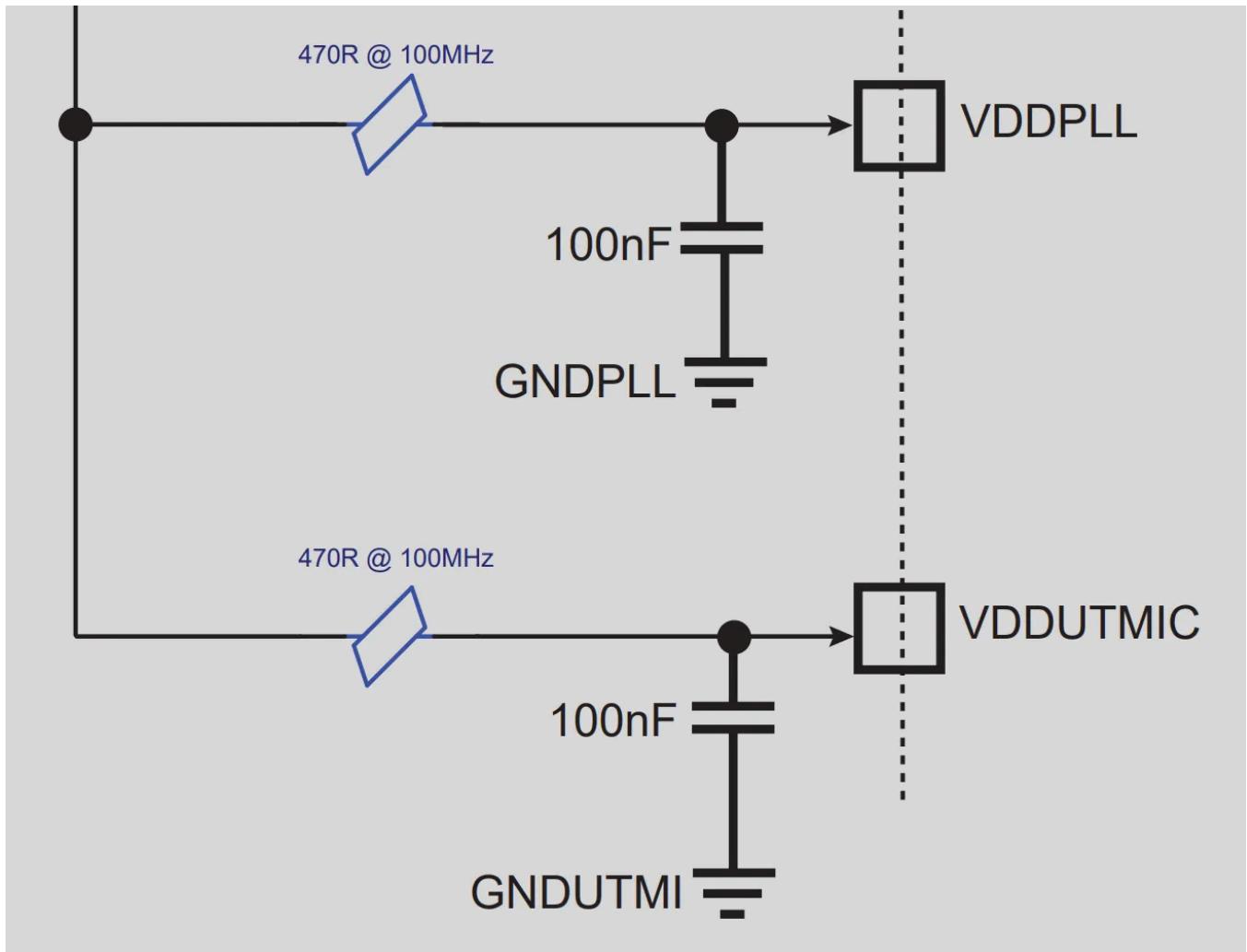
Is a capacitor always enough?

A well-chosen decoupling capacitor can greatly reduce switching noise, but the component has a finite capacitance and a non-zero impedance. The capacitor's impedance increases not only toward DC, but also toward very high frequencies; this is because of the fairly large, conductive surface area inside the device that forms a small inductor and limits the capacitor's response speed. The end result is that a typical MLCC can't supply high currents at (sine wave) frequencies above 100 MHz or so.

In other words, some attenuated high-frequency noise will inevitably get through — and while adding extra capacitors can offer some modest improvement, the strategy has diminishing returns.

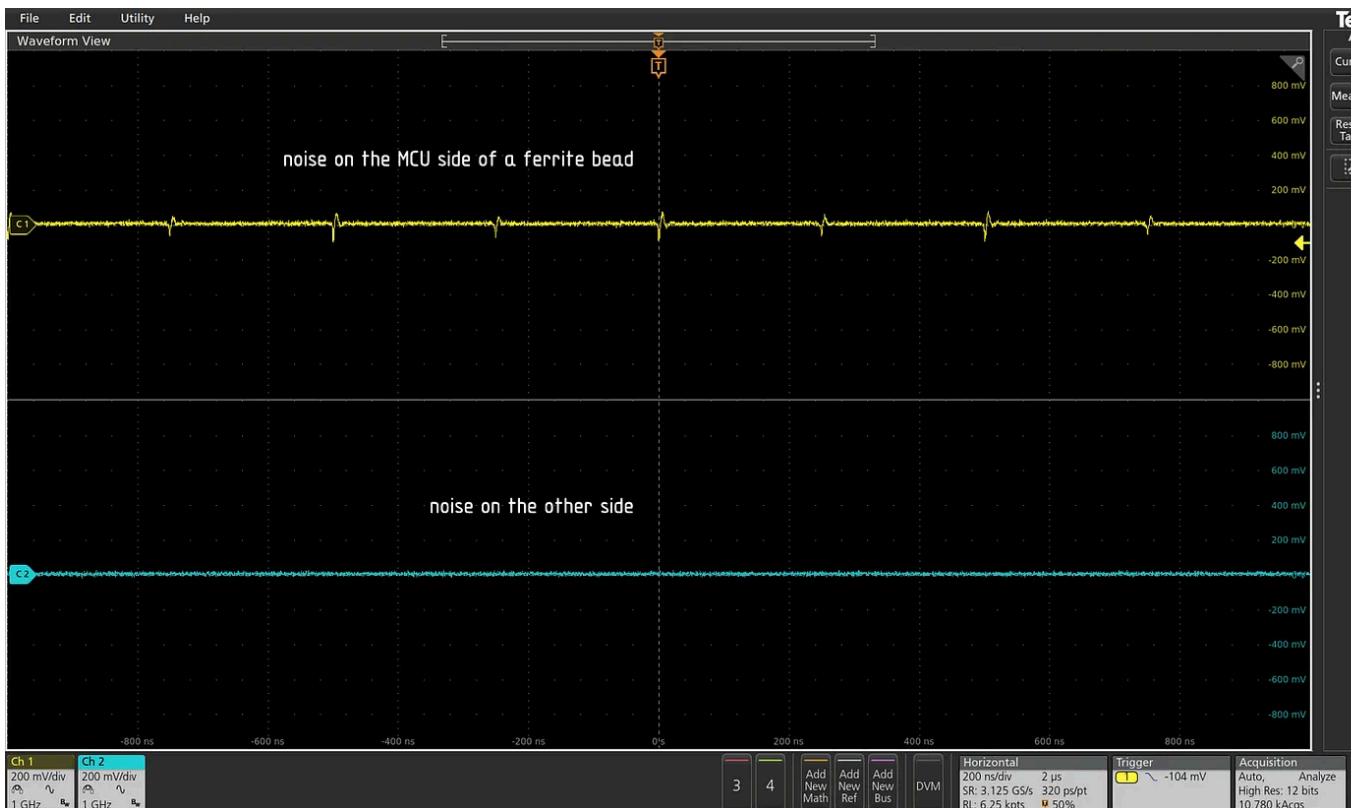
In sensitive circuits, the problem of this residual high-frequency noise can be further mitigated by placing a small ferrite bead in series with the supply line ahead of the decoupling caps. The inductor provides a low impedance path (few milliohms) for DC signals while impeding megahertz-range AC much better than a shunt capacitor to the ground can — usually performing well above 1 GHz or so, at which point parasitics once again get in the way.

The following example from the spec for SAM S70 MCUs, recommending the use of two beads with an impedance of 470Ω at 100 MHz on the supply lines for the USB transceiver and the phase-locked loop (PLL) clock multiplier:



Noise-filtering beads on MCU supply lines.

Combined with decoupling capacitors, the setup works remarkably well:



Noise containment afforded by a ferrite bead.

That said, it must be underscored that a ferrite bead doesn't eliminate noise; it merely contains it to the side it originated from. It can shield analog circuitry from digital switching artifacts, or it can protect the MCU from noise originating elsewhere; in all cases, it must be followed by a decoupling capacitor to provide some power reserve for downstream circuitry. An upstream (supply-side) capacitor is wise, too.

A related trick is to put small ferrite beads on MCU output lines; this takes the edge off fast-rising square wave signals, and can reduce needless currents and spurious radio frequency emissions when operating slower buses such as I₂C or SPI. In a pinch, small resistors might also do, although they will typically perform worse.

With this out of the way, most other noise mitigation techniques tend to revolve around board design. For example, keeping sensitive analog circuitry at an arm's length from digital signals is a good PCB layout strategy; so is placing an unbroken ground plane immediately under high-speed data lines.

to avoid forming large current loops that radiate wideband noise into the open space. (For a separate article on this topic, [click here](#).)

What if the manufacturer says...

The datasheets for some digital chips will outline a suggested way of decoupling them. These recommendations should not be ignored, but are to be taken as gospel. The manufacturer is trying to cover a variety of extremes, including:

- Circuits operated at the lowest permissible supply voltage,
- Devices running at the maximum supported clock speed,
- Peak utilization of on-chip peripherals,
- The customer using the worst decoupling capacitors money can buy (the "Y5V" variety that loses ~80% of rated capacitance when operated at elevated temperatures or near the cap's maximum voltage).

Further, the manufacturer is making assumptions about customers' design preferences. A typical 100 nF MLCC costs about \$0.005 a piece; in contrast, a 10 µF aluminum-polymer cap is about \$0.25. A customer doing robotic assembly might favor a dozen MLCCs in lieu of a single MLCC paired with a polymer capacitor. A hobbyist soldering by hand might not.

Instead of blindly following the spec — a practice that still doesn't guarantee success — it can be more useful to validate your design in three ways:

- Examine circuit supply noise under normal operating conditions. If the peaks exceed maximum permissible supply ripple, minimum supply voltage, or maximum supply voltage for the digital components, or if switching noise propagates to sensitive analog circuitry, you should improve the design.

- If relevant in your project, confirm that signals on any high-speed output busses (e.g., USB) look correct, especially in terms of expected rise and fall times, noise, and any periodic glitches. Oscilloscope “eye diagrams” can help.
- As a final test, observe the circuit with IC supply voltage reduced 10-20% from the design goal. If the digital circuitry continues to operate correctly, you likely have a good safety margin when it comes to switching noise.

What about the “1 nF / 10 nF / 100 nF” rule?

There is this old adage that for optimal decoupling, you must combine at least three capacitors, one or two decades (orders of magnitude) apart. The exact progression of recommended values changes from one oral account to another, but the bottom line is that if you don’t heed the warning, some terrible fate awaits.

The advice made some sense back when each of these capacitors would be made in a different technology. The lowest capacitance would be ceramic, offering low impedance but not packing enough punch to smooth out long-lasting flukes; the middle cap could be tantalum, offering balanced performance but not excelling in any dimension; and the last one would be aluminum electrolytic, delivering poor high-frequency response but storing quite a bit of juice.

Today, low-cost MLCCs combine high capacitance and low impedance across a wide range of frequencies, so there’s usually little to be gained by playing such tricks – at least not for circuits operating at “hobby” speeds. A single 1 nF or 1 μ F MLCC per each functionally distinct digital voltage supply line is almost always enough.

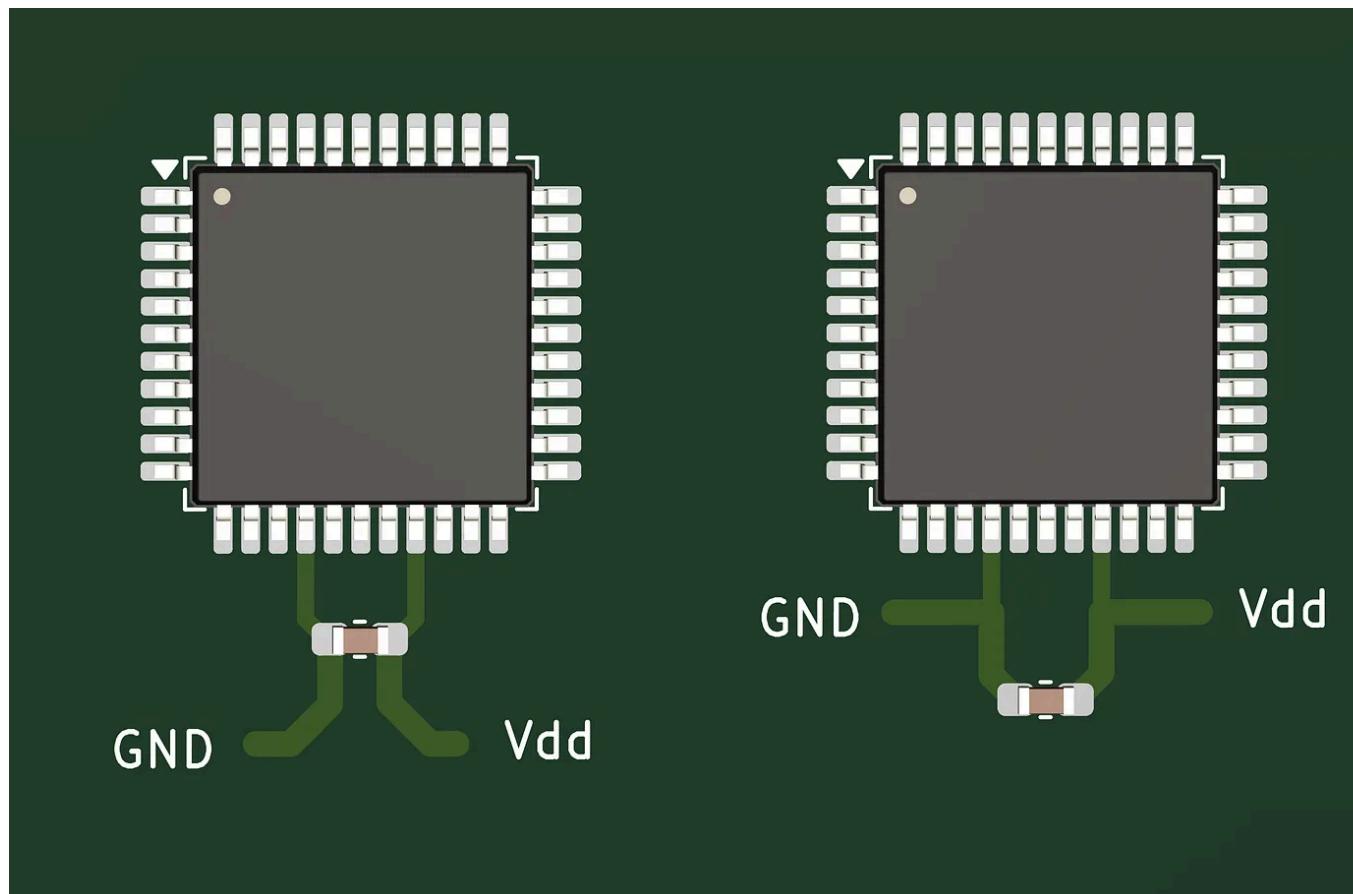
It is true that at very high frequencies – hundreds of megahertz – the capacitor’s residual inductance becomes a limiting factor. At that point, combining multiple different capacitors can offer somewhat better wideband performance.

noise suppression at the expense of potentially creating undesirable anti-resonance peaks in the system (rendering it ineffective at dealing with a handful of specific frequencies). That said, a simpler solution with fewer side effects is to use a specialized low-inductance (“low-ESL”) MLCC.

What about PCB layout?

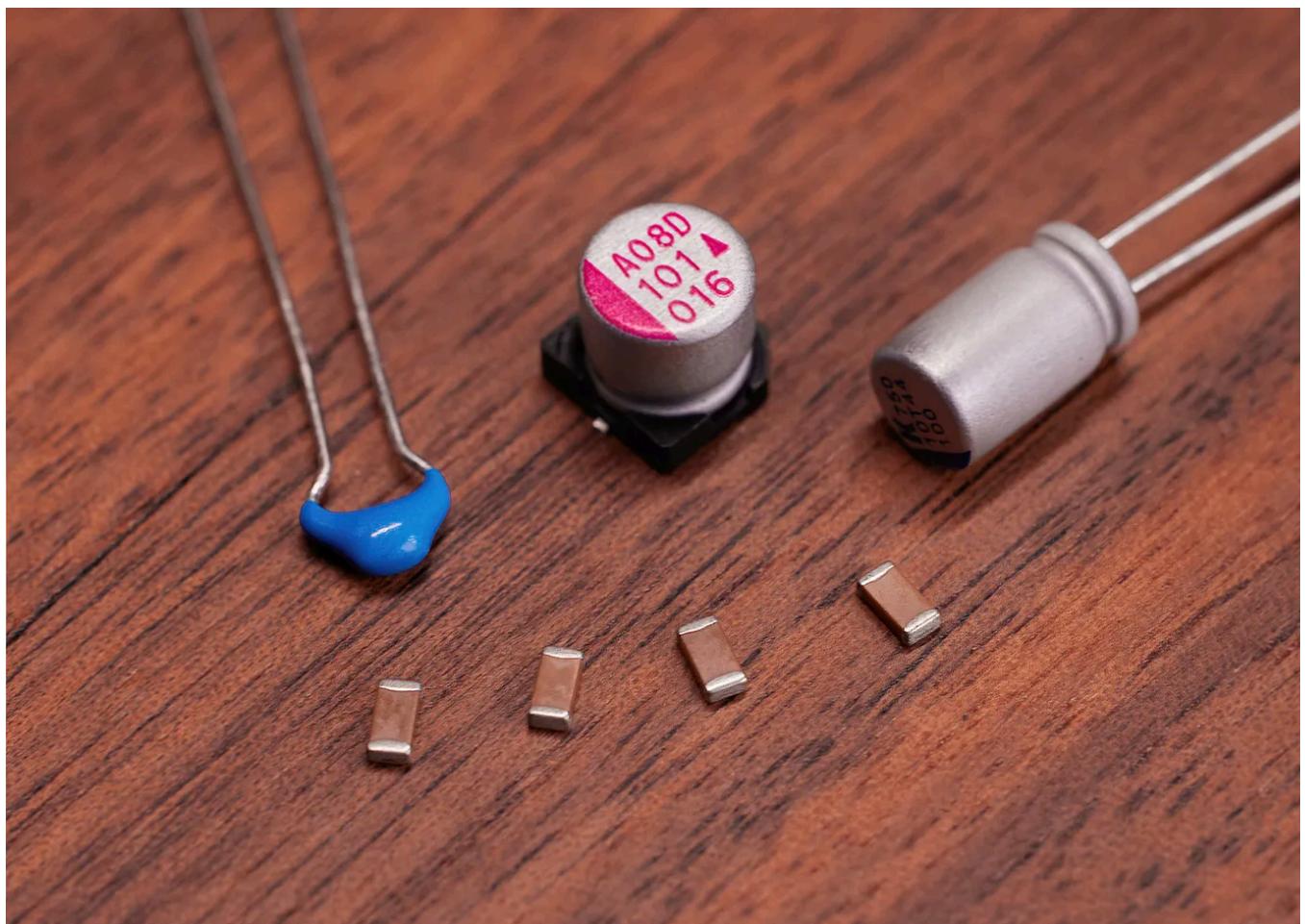
As discussed earlier on, it’s important to keep decoupling capacitors reasonably close to integrated circuits; the resistance and inductance of long traces prevents the caps from doing their job. As a rule of thumb, keep the distance under 1-2 cm whenever practical.

On the flip side, it’s best not to get sidetracked with more exotic advice found on the internet. One persistent claim is that the layout on the left is dramatically better than the one on the right:



Capacitor placement, taken to the extreme.

As the story goes, in the first circuit, voltage spikes reach the capacitor first allowing it to kick in before the noise “spills over” onto the supply lines. In second layout, the capacitor is supposedly reached too late. Don’t get me wrong: signal propagation speeds sometimes need to be taken into account in PCB design. That said, across such tiny distances, it doesn’t matter unless you’re working with multi-gigahertz signals — and in that frequency range your standard MLCC isn’t of much help.



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